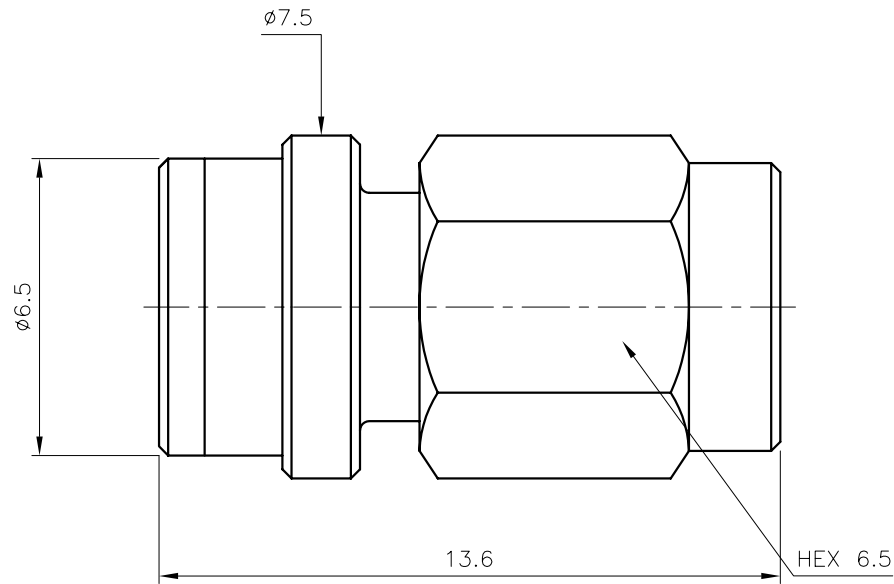


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	J.H.YOUN	2011.11.03.



9	RESISTOR	1			DRE00362-N/1
8	SPRING RING	1	BeCu	Gold Plate	DSR00003-5/1
7	CAP	1	SUS	부동태 처리	DCU00137-5/1
6	COVER	1	MBsBD	Nickel Plate	DCV00081-5/1
5	INSERT	1	MBsBD	Gold Plate	DIB00010-5/1
4	INSULATOR	1	TEFLON		DIN01954-N/1
3	GASKET	1	SILICONE RUB		DGK00003-N/1
2	CONTACT	1	MBsBD	Gold Plate	DCT02514-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD02980-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

ELECTRICAL SPECIFICATIONS		
1	FREQUENCY RANGE	DC ~ 4GHz
2	IMPEDANCE	50Ω NOMINAL
3	V.S.W.R	1.20 : 1 (Max)
4	POWER	1 Watt

TOLERANCE	Decimal ±0.1	DATE 2011. 11. 03.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY	J.H.YOUN				
MATERIAL	_____	CHECKED BY	TITLE SSMA50 P TERMINATION				
		DRAWN BY				I.C.KIM	
FINISH	_____	SCALE 6/1	UNIT mm		A4	DWG NO. TM00124-7/1	
						REVISION I R	SHEET 1 of 1